Base Band Hue/Color Control

Description

The CXA2039M is a bipolar color difference signal processing IC for color TVs. This chip enables base band hue and color control for color difference signals.

Features

- 2 UV inputs, 1 UV output
- 3 Y inputs, 2 Y outputs (1 of the 2 outputs outputs either of 2 inputs.)
- Built-in color difference signal delay line circuit

Absolute Maximum Ratings

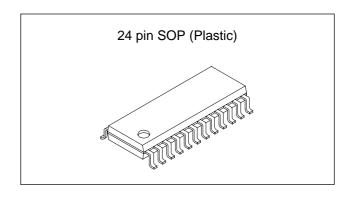
 Supply voltage 	Vcc	12	V
 Operating temperature 	Topr	-20 to +75	°C
Storage temperature	Tstg	-65 to +150	°C

• Allowable power dissipation

P_D 780 mW

Operating Conditions

Supply voltage Vcc 9 ± 0.5 V



Applications

Color TVs

Structure

Bipolar silicon monolithic IC

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Block Diagram

Pin Description

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
1 2 3	Y1 IN RY1 IN BY1 IN		70k	Y1, R-Y1 and B-Y1 signal inputs. Input the signals via capacitors.
4 14 20	GND			GND.
5	CLAMP		Vcc Vcc 8k 5 W 7/17 7/17	Clamp pulse (positive polarity) input. VILMAX = 2.5V VIHMIN = 3.5V
6	YUV SW		Vcc 60k Vcc 1.5k	YUV SW control. YUV SW ≤ 0.4V → Y2 IN, RY2 IN, and BY2 IN signals selected. YUV SW ≥ 1.0V → Y1 IN, RY1 IN, and BY1 IN signals selected.
7	LEVEL		Vcc 56k 7/// 7/// 7/// 7/// 7///	RY OUT, BY OUT and TV OUT output level control. VILMAX = 6.0V VIHMIN = 6.8V
8	Y OUT		Vcc Vcc Vcc Vcc 8	Y signal output. Outputs the signals input to Pins 1 and 23 attenuated by –6dB.

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
9	RY OUT		Vcc Vcc Vcc Vcc 9	R-Y signal output.
10	BY OUT		Vcc Vcc Vcc Vcc 30k	B-Y signal output.
11 24	Vcc	9V		Power supply.
12	TV OUT		Vcc ↓ 1k Vcc ↓ 30k 12 ↓ 30k	Y signal output.
13	DLY SW		Vcc 13	Delay on/off switching signal input. DLY SW ≤ 1.4V → Delay off DLY SW ≥ 2.2V → Delay on
15	DLY		Vcc	Delay line reference current setting. Connect to GND via a resistor. When $10k\Omega$ is connected, the delay time is 600ns. Increasing the resistance value increases the delay time and vice versa.

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
16	COLOR		Vcc 60k 16 W 20k	Color control. Control is performed by applying a voltage of 0 to 9V.
17	HUE		Vcc 60k 17 W → 1 20k ≶ 8k ≶ 8k 7/7 4.5V → 7/7	Hue control. Control is performed by applying a voltage of 0 to 9V.
18	Y SW		Vcc	Y SW control. DLY SW ≤ 1.4V → TV IN signal selected. DLY SW ≥ 2.2V → Y1 IN or Y2 IN signal selected (selected by YUV SW).
19	TV IN		19 Vcc Vcc Vcc Vcc Vcc Vcc Vcc Vcc Vcc Vc	Y signal input. Input the signal via a capacitor.
21 22 23	BY2 IN RY2 IN Y2 IN		21	Y2, R-Y2 and B-Y2 signal inputs. Input the signals via capacitors.

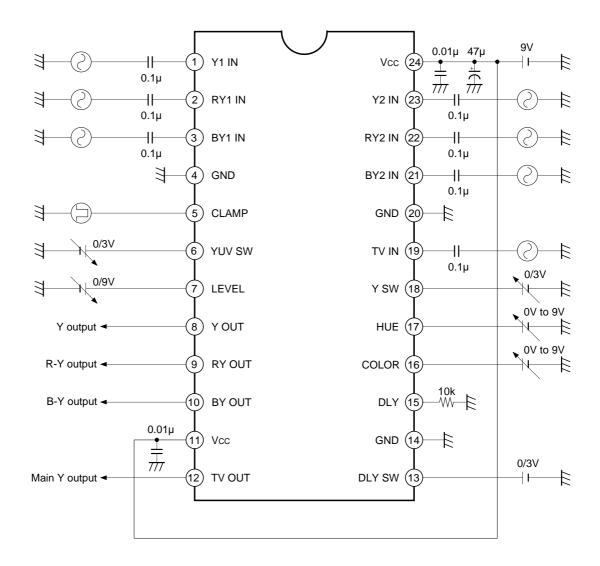
Electrical Characteristics

Setting conditions

- Ta = 25°C Vcc = 9V
- Set initially to: YUV SW = 0V, LEVEL = 0V, DLY SW = 0V, COLOR = 4.5V, HUE = 4.5V, Y SW = 0V. (when inputting the signals from Y2 IN, RY2 IN and BY2 IN)

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No.	Item	Symbol	Mea- sure- ment pin	Input signal	Measurement conditions and contents		Min.	Тур.	Max.	Unit
1	Current consumption	Icc	11 24		Vcc pin inflow current		14	19	24	mA
2	TV OUT output gain	VTV1	12			Gain SW = Low MODE LEVEL ≤ 6V	-7.0	-6.2	-5.0	dB
3	TV OUT output gain	VTV2	12		I/O gain	Gain SW = High MODE LEVEL ≥ 6.8V	-1.0	0	1.0	dB
4	Y OUT output gain	VY	8		I/O gain		-7.0	-6.2	-5.0	dB
5	RY OUT output gain	VRY1	9		I/O main	Gain SW = Low MODE LEVEL ≤ 6V	-7.0	-5.3	-4.0	dB
6	RY OUT output gain	VRY2	9	Y: 1.4Vp-p R-Y, B-Y: 0.7Vp-p	I/O gain	Gain SW = High MODE LEVEL ≥ 6.8V	-6.6	-4.7	-4.0	dB
7	BY OUT output gain	VBY1	10	▎▗▗▘ ▎	I/O gain	Gain SW = Low MODE LEVEL ≤ 6V	-4.7	-3.1	-1.7	dB
8	BY OUT output gain	VBY2	10		i/O gaiii	Gain SW = High MODE LEVEL ≥ 6.8V	-4.3	-2.3	-1.3	dB
9	Color variable range 1	Cmax.	9		Set the output when COLOR = 4.5V to 0dB and measure the output when COLOR = 9V.		5.3	6.1	6.8	dB
10	Color variable range 2	Cmin.	9		Set the output when COLOR = 4.5V to 0dB and measure the output when COLOR = 0 V.			-40	-30	dB
11	Hue variable range 1	Hmax.	10	B-Y = 0.7Vp-p R-Y = 0.5Vp-p when HUE = 9V Continue to the signal input only when HUE = 0V		40	48		Deg.	
12	Hue variable range 2	Hmin.	10				-48	-40	Deg.	
13	RY OUT Delay	RYDLY	9	0.7Vp-p	DLY SW = 3V. Measure the I/O delay.		530	600	680	ns
14	BY OUT Delay	BYDLY	10	1.	DLY SW Measure	' = 3V. the I/O delay.	530	600	680	ns
15	Y OUT frequency response	fY	8	Y signal 1.4Vp-p Y SW = 3V.		-1.0	0	1.0	dB	
16	RY OUT frequency response	fRY	9				-6.0	-3.5	0	dB
17	BY OUT frequency response	fBY	10	R-Y and B-Y signal 1.4Vp-p	Measure the 200kHz gain with respect to 5MHz.		-8.0	-5.0	-1.0	dB
18	TV OUT frequency response	fTV	12	200kHz, 5MHz			-1.0	0	1.0	dB

Electrical Characteristics Measurement Circuit



^{*} When performing measurements with signals input from Y1 IN, RY1 IN and BY1 IN: YUV SW = 3V

When performing measurements with signals input from Y2 IN, RY2 IN and BY2 IN: YUV SW = 0V

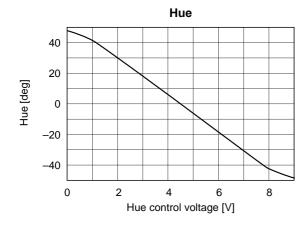
Description of Operation

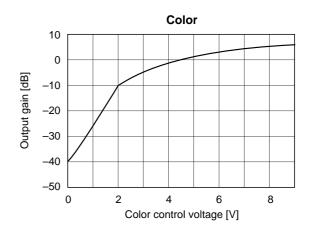
The Y, R-Y and B-Y signals input from Pins 1, 2, 3, 21, 22 and 23 are clamped by the clamp circuit and sent to the YUV SW circuit. The Y signal input from Pin 19 is clamped by the clamp circuit and then sent to the Y SW circuit.

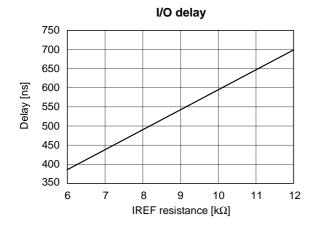
The YUV SW circuit receives the switching signal from Pin 6 and selects either the signals from Pins 1, 2 and 3 or from Pins 21, 22 and 23. The R-Y and B-Y signals output from the YUV SW circuit are attenuated and sent to the delay line and delay switch circuits. The delay time at the delay line circuit can be set as desired in the range of 500 to 700ns according to the resistance value connected between Pin 15 and GND. After passing through the delay line circuit, the signals are sent to the delay switch circuit where the Pin 13 control voltage is received and delay on/off switching is performed. The signals output from the delay switch circuit are input to the base band hue and color control circuits where the Pins 16 and 17 control voltages are received and hue and color control is performed. Then, the signals are amplified by the drive circuit and output from Pins 9 and 10. The drive circuit gain can be switched between two values according to the voltage applied to Pin 7. Two types of Y signals, 0dB and –6dB with respect to the input level, are output from the YUV SW circuit. The 0dB signal is sent as is to the Y SW circuit, and the –6dB signal is output from Pin 8.

The Y SW circuit receives the switching signal from Pin 18 and selects the Pin 19 signal and either the Pin 1 or Pin 23 signal selected by YUV SW. Two types of Y signals, an unadjusted signal and a signal attenuated by –6dB, are output from the Y SW circuit. These signals are sent to the level switch circuit where one of them is selected according to the voltage applied to Pin 7 and output from Pin 12.

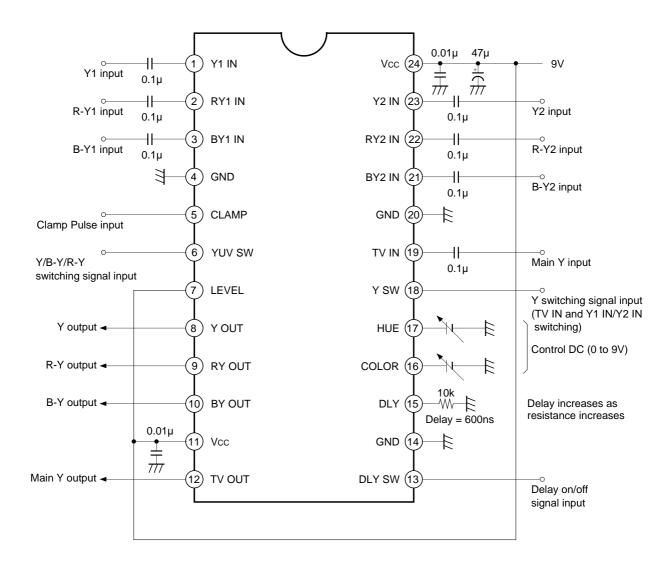
Curve Data







Application Circuit



Pin 7 (Pins 9, 10 and 12 output level switching)

9V = Output High MODE [RYOUT: -2.3dB (Typ.)/BYOUT: -4.7dB (Typ.)]

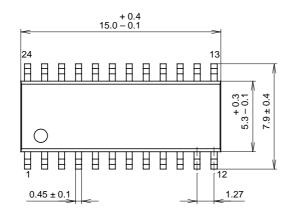
0V = Output Low MODE [RYOUT: -3.1dB (Typ.)/BYOUT: -5.3dB (Typ.)]

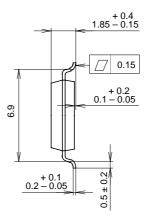
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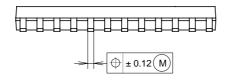
Package Outline

Unit: mm

24PIN SOP (PLASTIC)







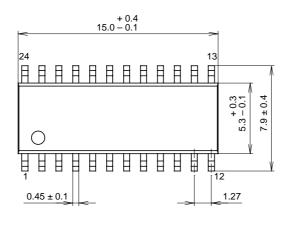
PACKAGE STRUCTURE

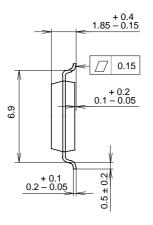
SONY CODE	SOP-24P-L01
EIAJ CODE	*SOP024-P-0300-A
JEDEC CODE	

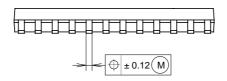
MOLDING COMPOUND	EPOXY/PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY / 42ALLOY
PACKAGE WEIGHT	0.3g

Package Outline Unit: mm

24PIN SOP (PLASTIC)







PACKAGE STRUCTURE

SONY CODE	SOP-24P-L01
EIAJ CODE	*SOP024-P-0300-A
JEDEC CODE	

MOLDING COMPOUND	EPOXY/PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY / 42ALLOY
PACKAGE WEIGHT	0.3g

LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	COPPER ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18μm